Preliminary



SF2202E-1

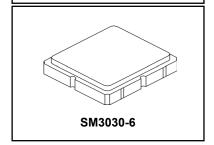
- Surface Mount 3.0 x 3.0 x 1.3 mm Package
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

| Rating | Value | Units |
|---|------------|-------|
| Input Power Level | 10 | dBm |
| DC Voltage on any Non-ground Terminal | 3 | V |
| Operating Temperature Range | -40 to +95 | °C |
| Storage Temperature Range | -40 to +95 | °C |
| Solder Reflow Temperature, 10 seconds, 5 cycles maximum | 260 | °C |

2017.5 MHz **SAW Filter**



Electrical Characteristics

| Characteristic | Sym | Min(-40~95°C) | Тур | Max(-40~85°C) | (-40~95°C) | Units |
|--------------------------------------|----------------|---------------|--------|---------------|------------|-------------------|
| Center Frequency | F _C | | 2017.5 | | | MHz |
| Insertion Loss, 2010 to 2025 MHz | IL | | 3.1 | 4.2 | 4.5 | dB |
| Amplitude Ripple, 2010 to 2025 MHz | | | 0.4 | 1.4 | 1.8 | dB _{P-P} |
| VSWR, 2010 to 2025 | | | 1.3:1 | | 2.5:1 | |
| Group Delay Ripple, 2010 to 2025 MHz | | | 9 | 30 | 30 | ns _{P-P} |
| Attenuation, Referenced to 0 dB | | | | | | |
| 1700 to 1785 MHz | | 40 | 50 | | | |
| 1800 to 1860 MHz | | 45 | 51 | | | |
| 1920 to 1980 MHz | | 30 | 37 | | | dB |
| 2045 to 2070 MHz | | 6 | 33 | | | T UB |
| 2070 to 2085 MHz | | 15 | 54 | | | |
| 2170 to 4000 MHz | | 30 | 33 | | | |
| Source Impedance | Z _S | | 50 | | | Ω |
| Load Impedance | Z _L | | 50 | | | |

| Case Style | SM3030-6 3.0 x 3.0 mm Nominal Footprint | |
|--|---|--|
| Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator | 947, YWWS | |
| Standard Reel Quantity Reel Size 7 Inch | 500 Pieces/Reel | |
| Reel Size 13 Inch | 3000 Pieces/Reel | |

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.

Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
"LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

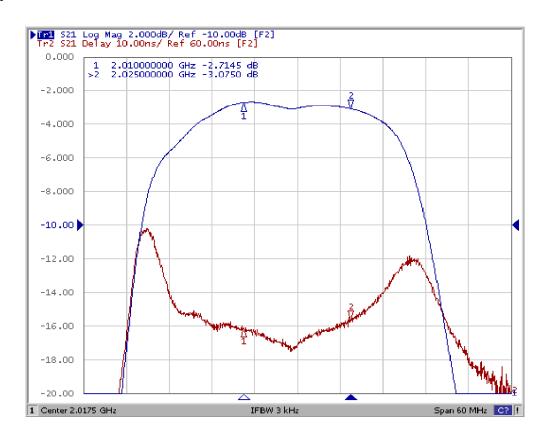
The design, manufacturing process, and specifications of this filter are subject to change.

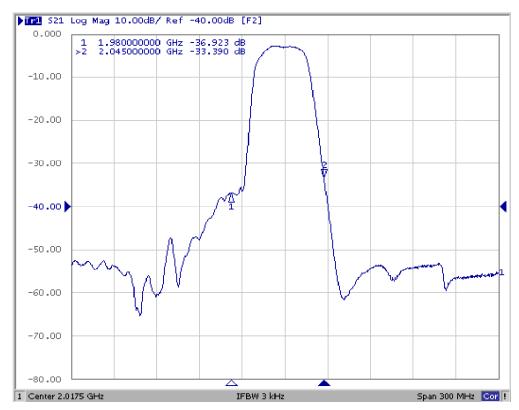
Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.

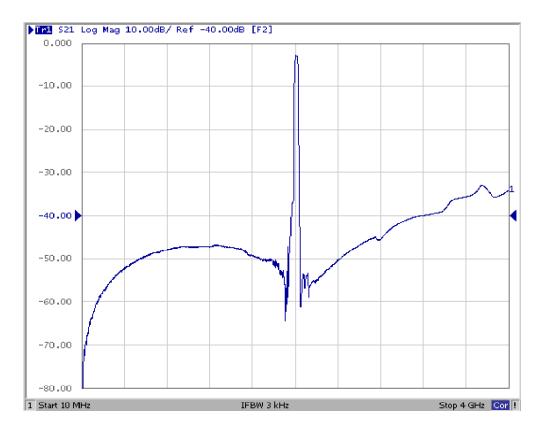
US and international patents may apply.

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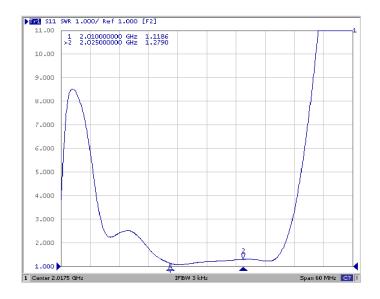
Filter Response Plots

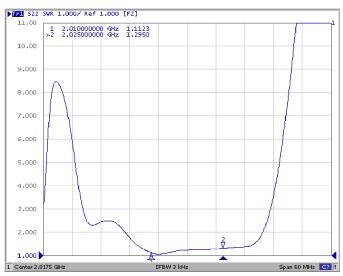






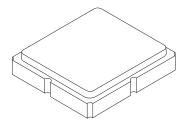
Filter VSWR Plots

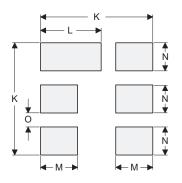




SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





PCB Footprint Top View

Case and PCB Footprint Dimensions

| Dimension | mm | | | Inches | | |
|-------------|------|------|------|--------|-------|-------|
| Difficusion | Min | Nom | Max | Min | Nom | Max |
| Α | 2.87 | 3.00 | 3.13 | 0.113 | 0.118 | 0.123 |
| В | 2.87 | 3.00 | 3.13 | 0.113 | 0.118 | 0.123 |
| С | 1.12 | 1.25 | 1.38 | 0.044 | 0.049 | 0.054 |
| D | 0.77 | 0.90 | 1.03 | 0.030 | 0.035 | 0.040 |
| E | 2.67 | 2.80 | 2.93 | 0.105 | 0.110 | 0.115 |
| F | 1.47 | 1.60 | 1.73 | 0.058 | 0.063 | 0.068 |
| G | 0.72 | 0.85 | 0.98 | 0.028 | 0.033 | 0.038 |
| Н | 1.37 | 1.50 | 1.63 | 0.054 | 0.059 | 0.064 |
| I | 0.47 | 0.60 | 0.73 | 0.019 | 0.024 | 0.029 |
| J | 1.17 | 1.30 | 1.43 | 0.046 | 0.051 | 0.056 |
| K | | 3.20 | | | 0.126 | |
| L | | 1.70 | | | 0.067 | |
| М | | 1.05 | | | 0.041 | |
| N | | 0.81 | | | 0.032 | |
| 0 | | 0.38 | | | 0.015 | |

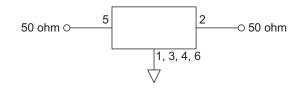
Case Materials

| Materials | | | | |
|-----------------------|--|--|--|--|
| Solder Pad Plating | 0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel | | | |
| Lid Plating | 2.0 to 3.0 µm Nickel | | | |
| Body | Al ₂ O ₃ Ceramic | | | |
| Pb Free | | | | |

Electrical Connections

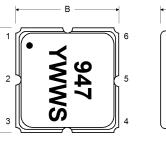
SF2202E-1 (R) 8/3/15

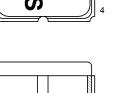
| Connection | Terminals |
|------------|------------|
| Input | 5 |
| Output | 2 |
| Ground | All Others |

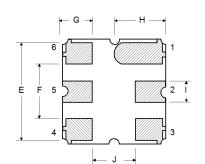


BOTTOM VIEW

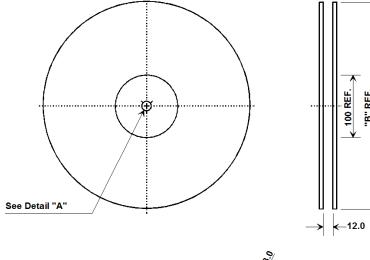
TOP VIEW



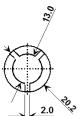




Tape and Reel Specifications



| | "B" | Quantity Per Reel |
|--------|-------------|-------------------|
| Inches | millimeters | |
| 7 | 178 | 500 |
| 13 | 330 | 3000 |



COMPONENT ORIENTATION and DIMENSIONS

| Carrier Tape Dimensions | | | | |
|-------------------------|---------|--|--|--|
| Ao | 3.35 mm | | | |
| Во | 3.35 mm | | | |
| Ко | 1.40 mm | | | |
| Pitch | 8.0 mm | | | |
| W | 12.0 mm | | | |

